

Product Technical Specifications

Project Name: IMA2A series

Author: Wistron NeWeb Corporation

Revision: 1.0

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Contact Information

| Technical Support Website | https://supportiot.wnc.com.tw/ | |
|---------------------------|--------------------------------|--|
| Company Website | www.wnc.com.tw | |

Revision History

| Rev. # | Author | Summary of Changes | Date |
|--------|--------|------------------------|-----------|
| 1.0 | WNC | First official release | 2018/7/27 |
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Responsible company : W-NeWeb CorporationResponsible address:1525 McCarthy Blvd, Suite 206, Milpitas, CA 95035, U.S.A.Responsible name:Chun Tsung LeeContact Number:+1 4084576800 #6802

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FCC Regulations:

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) This device must accept any interference received, including interference that may cause undesired operation.

This device has been tested and found to comply with the limits for a Class B digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiated radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

-Reorient or relocate the receiving antenna.

-Increase the separation between the equipment and receiver.

-Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.

-Consult the dealer or an experienced radio/TV technician for help.

Caution: Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

RF Exposure Information

This device complies with FCC radiation exposure limits set forth for an uncontrolled environment. In order to avoid the possibility of exceeding the FCC radio frequency exposure limits, human proximity to the antenna shall not be less than 20cm (8 inches) during normal operation.

Standalone Condition:

- $^{\circ}$ 8 dBi in 700 MHz Band
- ° 5 dBi in 1700 MHz Band
- ° 5 dBi in 1900 MHz Band

Assuming collocated with a WLAN transmitter with maximum 20 dBm average EIRP power



- 7 dBi in 700 MHz Band
- 4 dBi in 1700 MHz Band
- ° 4 dBi in 1900 MHz Band

Remark: This assumption is not valid if the output power of the collocated WLAN transmitter is higher than 20 dBm.

ISED Notice

This device complies with Innovation, Science and Economic Development Canada license-exempt RSS standard(s). Operation is subject to the following two conditions:

(1) this device may not cause interference, and

(2) this device must accept any interference, including interference that may cause undesired operation of the device.

Le présent appareil est conforme aux CNR Innovation, Sciences et Développement économique Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes:

(1) l'appareil ne doit pas produire de brouillage, et

(2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en

Innovation, Science and Economic Development Canada ICES-003 Compliance Label:

CAN ICES-3 (B)/NMB-3(B)

This Class B digital apparatus complies with Canadian ICES-003.

Cet appareil numérique de la classe B est conforme à la norme NMB-003 du Canada.

ISED Radiation Exposure Statement

This device complies with RSS-102 radiation exposure limits set forth for an uncontrolled environment. In order to avoid the possibility of exceeding the ISED radio frequency exposure limits, human proximity to the antenna shall not be less than 20cm (8 inches) during normal operation.

Cet appareil est conforme aux limites d'exposition aux rayonnements de la CNR-102 définies pour un environnement non contrôlé. Afin d'éviter la possibilité de dépasser les limites d'exposition aux fréquences radio de la CNR-102, la proximité humaine à l'antenne ne doit pas être inférieure à 20 cm (8 pouces) pendant le fonctionnement normal.

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IMPORTANT NOTE:

This module is intended for OEM integrator. The OEM integrator is still responsible for the FCC compliance requirement of the end product, which integrates this module. 20cm minimum distance has to be able to be maintained between the antenna and the users for the host this module is integrated into. Under such configuration, the FCC radiation exposure limits set forth for an population/uncontrolled environment can be satisfied.

Any changes or modifications not expressly approved by the manufacturer could void the user's authority to operate this equipment.

USERS MANUAL OF THE END PRODUCT:

In the users manual of the end product, the end user has to be informed to keep at least 20cm separation with the antenna while this end product is installed and operated. The end user has to be informed that the FCC radio-frequency exposure guidelines for an uncontrolled environment can be satisfied. The end user has to also be informed that any changes or modifications not expressly approved by the manufacturer could void the user's authority to operate this equipment. If the size of the end product is smaller than 8x10cm, then additional FCC part 15.19 statement is required to be available in the users manual: This device complies with Part 15 of FCC rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference and (2) this device must accept any interference received, including interference that may cause undesired operation.

LABEL OF THE END PRODUCT:

The final end product must be labeled in a visible area with the following " Contains Transmitter Module FCC ID: NKRIMA2A". If the size of the end product is larger than 8x10cm, then the following FCC part 15.19 statement has to also be available on the label: This device complies with Part 15 of FCC rules.

Operation is subject to the following two conditions: (1) this device may not cause harmful interference and (2) this device must accept any interference received, including interference that may cause undesired operation.

The Innovation, Science and Economic Development Canada certification label of a module shall be clearly visible at all times when installed in the host device; otherwise, the host device must be labeled to display the Innovation, Science and Economic Development Canada certification number for the module, preceded by the words "Contains transmitter module IC:4441A-IMA2A".

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| 2 |
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1. Introduction

The WNC IMA2A series modules include the Altair ALT1250 Cat. M1 baseband, a complete LTE RF front-end, memory, and required circuitry to fulfill 3GPP E-UTRA and AT&T Wireless LTE Cat. M1 UE specifications. The following table enumerates the frequencies supported by the IMA2A series modules.

| Band | Uplink (MHz) | Downlink (MHz) |
|-------------------------|--------------|----------------|
| LTE Band 2 | 1,850–1,910 | 1,930–1,990 |
| LTE Band 4 | 1,710–1,755 | 2,110–2,155 |
| LTE Band 12 | 699–716 | 729–746 |
| Table 1-1. Band support | | |

| Module | Power class | GNSS |
|--------|-------------|------|
| IMA2A | 3 | × |

Table 1-2 SKU description

1.1 General Features

The table below summarizes the IMA2A module features.

| | • JTAG |
|------------------------------------------|----------------------------------------------------------------|
| General interfaces | • USIM |
| | • GPIO |
| | • UART |
| | • LTE Band 2 |
| Supported frequency bands | • LTE Band 4 |
| frequency bands | • LTE Band 12 |
| Operating voltage | • V _{cc} (range: 3.3 V–4.2 V) |
| | • LGA module |
| Packaging | • 104 pads (19.2 mm × 14.7 mm × 2.152 mm) |
| | RoHS compliant |
| Table 1-3. General features of the IMA2A | |
| Standards | • 3GPP Release 13–compliant; software upgradable to |
| compliance | Release 14 |
| DUN | Category M1: Up to 300 Kbps DL/375 Kbps UL |
| РНҮ | HD-FDD duplexing support |

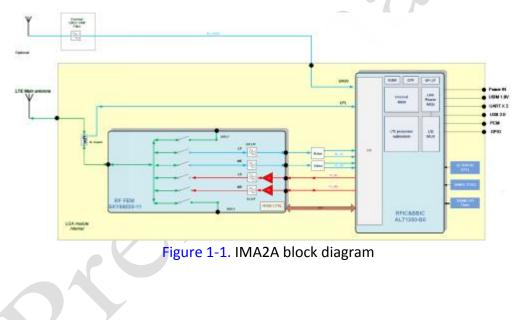


| | Power-saving mode | |
|---------------|---------------------------------------------------------------------------------------------------|--|
| | Random access procedure in normal subframes | |
| MAC | Scheduling request, buffer status reporting, and power headroom reporting | |
| | • Discontinuous reception (eDRX) with long and short cycles | |
| | • IPv4, IPv6 | |
| | • NAS | |
| NAS and above | • SMS over SG | |

Table 1-4. LTE-related features of the IMA2A

1.2 Architecture

The architecture block diagram of the IMA2A is presented in Figure 1-1 below.



1.3 Connection Interface

The IMA2A module is a LGA device. All electrical and mechanical connections are made through the 104 pads on the bottom side of the PCB.

1.4 Environmental Specifications and Certifications

1.4.1 Environmental Specifications

The environmental specifications for both operating and storage conditions are



defined in the table below.

| Condition | Temperature Range | Remark |
|-------------------------------------------|------------------------------|-----------------------------------------------------------------------------------------------------------------------|
| Normal ambient operating temp. range | $-20^{\circ}(10.60^{\circ})$ | Fully functional and complies with 3GPP specifications |
| Extended ambient operating temp. range | –40 °C to 85°C | RF performance may be affected outside normal ambient operating range temp., although the module will still function. |
| Storage | –40 °C to 85 °C | |

Table 1-5. Temperature range

1.4.2 Certifications

The IMA2A module is compliant with the following regulations: PTCRB, FCC, IC, and AT&T TA.

1.4.3 Green Product Compliance

RoHS (2011/65/EU)

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2. Pin Definitions

2.1 LGA Module Pin Diagram

The IMA2A LGA module pin layout is illustrated below.

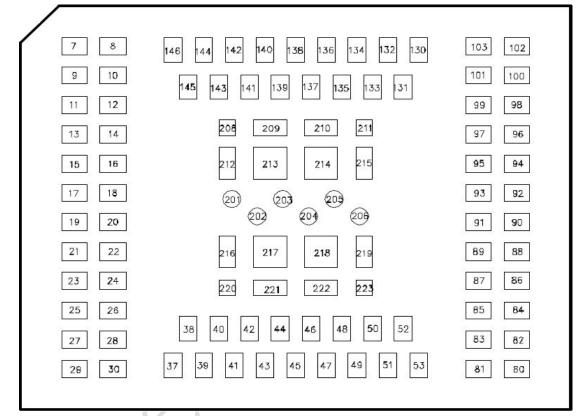


Figure 2-1. IMA2A LGA module pin layout (top view)

2.2 LGA Module Pin Definitions

The signals and all the related details are listed in the below table.

| Pin No. | Name | Description |
|---------|---------|-------------|
| 7 | GND | GND |
| 8 | GND | GND |
| 9 | RF_GNSS | RF_GNSS_ANT |
| 10 | GND | GND |
| 11 | GND | GND |
| 12 | GND | Ground |
| 13 | GND | Ground |

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| 14 | GND | Ground |
|----|-----------------|----------------------------------------|
| 15 | Main antenna | Main antenna port |
| 16 | GND | Ground |
| 17 | GND | Ground |
| 18 | GND | Ground |
| 19 | GND | Ground |
| 20 | GND | Ground |
| 21 | NC | Not connected |
| 22 | GND | Ground |
| 23 | GND | Ground |
| 24 | GND | Ground |
| 25 | GND | Ground |
| 26 | GND | Ground |
| 27 | NC | Not connected |
| 28 | GND | Ground |
| 29 | GND | Ground |
| 30 | GND | Ground |
| 37 | Power | Power |
| 38 | Power | Power |
| 39 | Power | Power |
| 40 | Power | Power |
| 41 | Power | Power |
| 42 | Power | Power |
| 43 | PMU_VBACKUP | Power input for real time clock |
| 44 | GND | Ground |
| 45 | GND | Ground |
| 46 | PCM_FS/GPIO46 | PCM/General purpose input/output |
| 47 | PCM_IN/GPIO47 | PCM/General purpose input/output |
| 48 | | PCM/General purpose input/output |
| 49 | PCM_CLK/GPIO49 | PCM/General purpose input/output |
| 50 | GND | Ground |
| 51 | GND | Ground |
| 52 | I2C1_SCL/GPIO01 | I2C/General purpose input/output |
| 53 | I2C1_SDA/GPIO02 | I2C/General purpose input/output |
| 80 | PMU_AT_IN | Anti-tamper input |
| 81 | PMU_AT_OUT | Anti-tamper output |
| 82 | | Alarm output |
| 83 | DEBUG_SEL | Hardware pin for EJTAG chain selection |

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| 84 | GND | Ground |
|-----|------------------------|-----------------------------------------|
| 85 | GND | Ground |
| 86 | USB_Dp | USB data positive |
| 87 | VBUS | USB 3.3V input voltage supply |
| 88 | USB_Dn | USB data negative |
| 89 | GND | Ground |
| 90 | GND | Ground |
| 91 | GND | Ground |
| 92 | UARTO_CTS | Clear to send for UART 0 |
| 93 | UARTO_TX | Transmit for UART 0 |
| 94 | UART2_TX | Transmit for UART 2 |
| 95 | UARTO_RX | Receive for UART 0 |
| 96 | UART2_RX | Receive for UART 2 |
| 97 | UARTO_RTS | Request to send for UART 0 |
| 98 | UART2_RTS | Request to send for UART 2 |
| 99 | UART2_CTS | Clear to send for UART 2 |
| 100 | GPIO100 | General purpose input/output |
| 101 | GNSS_EN | For external LNA enable |
| 102 | GPIO102 | General purpose input/output |
| 103 | GPIO103 | General purpose input/output |
| 130 | ADC1 | Analog-to-digital converter |
| 131 | ADC2 | Analog-to-digital converter |
| 132 | GPIO08 | General purpose input/output |
| 133 | UIM_VCC | SIM card power |
| 134 | UIM DATA | SIM card data line |
| 135 | UIM CLK | SIM card clock line |
| 136 | UIM RESET | SIM card reset line |
| 137 | UIM DETECT | SIM card detect line |
| 138 | NC | Not connected |
| 139 | GND | Ground |
| 140 | GND | Ground |
| 141 | WWAN_STATE | Wireless WAN radio state |
| 142 | Power on ¹ | Power-on of the module (RFU) |
| 143 | WAKEUP_OUT | Module wake-up of the host |
| 144 | WAKEUP_IN ² | Host wake-up of the module |
| 145 | RESET | Hardware reset signal |
| 146 | VREF ³ | Reference logic voltage (1.8 V voltage) |
| 201 | EJ_TCK | EJ_TCK |
| 202 | EJ_TDI | EJ_TDI |

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| | 1 | |
|-----|------------|------------------------------|
| 203 | EJ_TDO | EJ_TDO |
| 204 | EJ_TMS | EJ_TMS |
| 205 | EJ_TRST | EJ_TRST |
| 206 | DEBUG_RSTN | Reset pin for the JTAG probe |
| 208 | GND | Ground |
| 209 | GND | Ground |
| 210 | GND | Ground |
| 211 | GND | Ground |
| 212 | GND | Ground |
| 213 | GND | Ground |
| 214 | GND | Ground |
| 215 | GND | Ground |
| 216 | GND | Ground |
| 217 | GND | Ground |
| 218 | GND | Ground |
| 219 | GND | Ground |
| 220 | GND | Ground |
| 221 | GND | Ground |
| 222 | GND | Ground |
| 223 | GND | Ground |
| | | |

Table 2-1. IMA2A module pin definitions

Notes:

1: Leave pin 142 floating; the module can be turned on automatically when a power supply exists.

2: Pin 144 can be used as a wake-up as the module enters deep-sleep status. The default configuration is active high to wake up the LGA module.

3: The VREF voltage will turn off when entering the deep sleep state.

4:UART signal is better to retain in low state before the ALT1250 voltage is ready.

5:145 pin EXT_RST_N should use external 1.8V for pull up voltage



3. Electrical Specifications

3.1 Power Supply

The IMA2A module is supplied through the power signal with the following characteristics.

| | Direction | Minimum | Typical | Maximum |
|-----------------|-----------|---------|---------|---------|
| Power (37–42) | In | 3.3 V | 3.8 V | 4.2 V |
| VREF | Out | 1.71 V | 1.8 V | 1.89 V |
| SIM_VCC (1.8 V) | Out | 1.71 V | 1.8 V | 1.89 V |

Table 3-1. Power supply

3.2 Power Consumption

This section describes the typical power consumption of the IMA2A (for reference).

| Powering on | Conditions | Result |
|-----------------|------------------------------------------------------------------------------------------|---------|
| Peak power cons | sumption | |
| | TBD | TBD |
| Power off | Conditions | Result |
| Power off consu | mption | |
| | Only the module; no other devices; only RTC functions in deep sleep. | 1.7μΑ |
| Working Mode | Conditions | Result |
| LTE Band 2 work | ing mode | |
| | Max Tx power without throughput, power voltage 3.8 V; average current, CMW500 eMTC mode. | 239.4mA |
| LTE Band 4 work | ing mode | • |
| | Max Tx power without throughput, power voltage 3.8 V; average current, CMW500 eMTC mode. | 255.2mA |
| LTE Band 12 wor | king mode | |
| | Max Tx power without throughput, power voltage 3.8 V; average current, CMW500 eMTC mode. | 259.7mA |



| Low power | Conditions | Result |
|---------------|--------------------------------------------------|---------|
| Mode | | |
| Idle mode | | - |
| | LTE Standby, 1.28s | 6.7mA |
| | LTE Standby, 2.56s | 5.2mA |
| e-DRX mode | | - |
| | e-DRX cycle =81.96s,Paging cycle=1.28s,PTW=2.56s | TBD |
| PSM mode | | • |
| | T3412-Extended=24H,T3324=10s | 0.012mA |
| | One PSM cycle per day. | |
| Rock bottom c | urrent | |
| | Only the module; no other devices; only RTC | 1.7 μΑ |
| | functions in deep sleep. | |

Note: The power consumption is under optimizing.

Table 3-2. LTE power consumption

3.3 Control Interfaces

This section describes the power on/off, wake-up, and reset interface for controlling the module.

3.3.1 Power-On Signal

This function is not available in the present firmware; the module will be turned on automatically when the power supply exists. Set this pin as "floating" or use 0 Ω as a reserve.

3.3.2 Wake-Up Interface

In applications where power consumption is a major factor in performance metrics (such as battery-operated sensors that are based on IOT/M2M modem solutions and also include a third-party host), it is necessary to define a simple interface that will enable the modem or the host to independently enter low power states whenever possible and the other respective modem or host side to wake it up once required.

For example, if the host has no data to transmit or any other tasks to perform, it may enter some low power state according to its own capabilities and configurations. If during that period the host is in a low power state and the modem then receives data, it must wake-up the host.

A similar converse requirement exists. For example, if the modem is in a low power



state and the host then must transmit data, it must be able to wake-up the modem.

The interface consists of two signals: One is driven by the host and received by the modem; the other is driven by the modem and received by the host.

Each side can wake the other by toggling a wakeup signal high and allowing the other to enter sleep mode when not required by toggling it low.

- "WAKEUP_IN" (Host: Output; Modem: Input):
 - LOW: The SoC does not require the Modem (allowing it to sleep).
 - HIGH: The SoC requires the Modem or acknowledges it is ready

following a wakeup request from the Modem.

- "WAKEUP_OUT" (Host: Input; Modem: Output):
 - LOW: The Modem does not require the Host (allowing it to sleep).
 - HIGH: The Modem requires the Host or acknowledges it is ready following a wakeup request from the SoC.

Note: WAKEUP_OUT function will be updated in the future.

3.3.3 Reset Signal

The Reset Signal is a hardware reset signal to control the system reset directly. You can connect it to a key or a control signal. Reserve a 100k resistor to pull up to VREF and maintain a sufficient physical distance between the reset signal trace and noise and radiating signals on the PCB.

3.3.4 WWAN state

Note:WWAN_STATE function will be updated in the future.

3.4 UART Interface

There are two UART interfaces: a 4-bit for high-speed data transfer, and the UARTs. Definitions of the IMA2A are listed below.

1. UARTO for PPP and AT



2. UART2 for firmware download, recovery mode, and firmware debug view

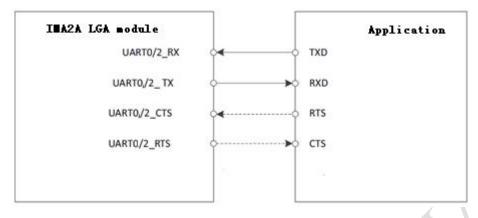


Figure 3-1. UART connection (example)

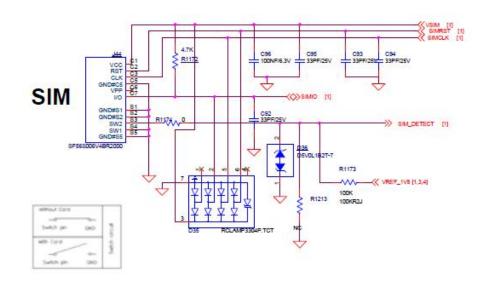
3.5 UIM Interface

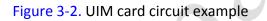
IMA2A modules provide a UIM_DETECT input pin for UIM connectors to detect a UIM card. When a UIM card is present, UIM_DETECT should be high (1.8 V). If a UIM card is absent, UIM_DETECT should be low. Pulling UIM_DETECT to VREF with a 100k resistor is necessary. We recommend placing a 0.1 μ F and a 33 pF capacitor between UIM_VCC and the Ground in parallel. We also recommend placing a 33 pF capacitor between UIM_RESET, UIM_CLK, and UIM_DATA and the Ground in parallel. Refer to Figure 5 for details.

We also recommend placing an electrostatic discharge (ESD) protection circuit near the UIM socket as close as possible. The Ground pin of the ESD protection component must be well-connected to the Ground plane.

The following figure shows an example of a UIM card circuit. The default configuration is active High.







3.6 I/O Characteristics

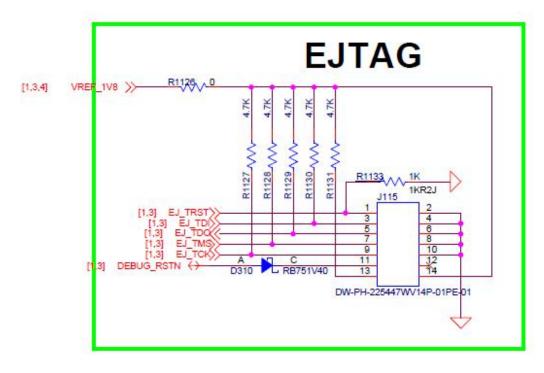
The voltage and current characteristics of the various IO pads of the IMA2A versus IO bank supply voltage are illustrated in the tables below.

| Parameter | Drive Strength | Min. | Nom. | Max. | Unit |
|--------------------|-------------------|-------------------------|------|-----------|------|
| VIL | | | | 0.3 × VIO | V |
| Input Low Voltage | | | | 0.3 × 010 | v |
| VIH | | 0.7 × VIO | | | V |
| Input High Voltage | | 0.7 × 010 | | | v |
| VOL | | | | | |
| Output Low | | | | 0.2 × VIO | V |
| Voltage | | | | | |
| VOH | | | | | |
| Output High | | 0.8 × VIO | | | |
| Voltage | | | | | |
| VH | | $0.1 \times \text{VIO}$ | | | V |
| Input Hysteresis | | 0.1 × 110 | | | V |
| IRATED | 2 4 | | | 10 | |
| IO Drive Strength | 2 mA | | | 12 | mA |

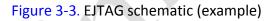
Table 3-3. DC characteristics for digital IOs, voltage 1.8 V—BIDIR and IN types

3.7 EJTAG Interface

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The IMA2A series provides one EJTAG interface; leave JTAG pins floating if not used.



3.8 ADC Interface

The IMA2A contains two ADC ports; the characteristics will be updated according to the ALT1250 datasheet in the future.

| Symbol | Parameter | Min. | Тур. | Max. | Unit |
|--------|-----------------|------|-----------|-----------|------|
| Ν | Resolution | 6 | | 12 | Bits |
| FCLK | Clock rate | 4 | 40 | 52 | MHz |
| FS | Conversion rate | | Fc /(N+3) | 0.2 × VIO | MSPS |
| | per channel(1) | | | | |
| VIN | Input voltage | | 1.8 | | v |
| | range | | 1.0 | | v |

| Symbol | Parameter | Min. | Тур. | Max. | Unit |
|--------|------------------------------|------|------|------|------|
| INL | Integral Nonlinearity | | ±1 | ±2 | LSB |
| DNL | Differential Nonlinearity | -0.9 | | 0.9 | LSB |



| SINAD | Signal to Noise and Distortion ratio(2) | 64.5 | | dB |
|-------|-----------------------------------------------|------|-----|-----|
| OE | Offset error | ±1 | ±2 | %Fs |
| GE | Gain error | ±1 | ±2 | %Fs |
| RIN | Input resistance | | 0.5 | KΩ |
| CIN | Input capacitance during sampling | 2.6 | | pF |

Table 3-4. ADC characteristics

(1) The general formula for this conversion rate is: FS=FCLK/(N+3)/Number of sources.

(2) Conversion rate at 3.46 MSPS and 12bit resolution

3.9 RF Interface

Each IMA2A module has only one RF pad; developers must connect it via the 50 Ω traces to the main board.

| Main antenna | pad (Pin15) – RX/TX path |
|--------------|----------------------------|
| | pau (Fili15) – Kky ik paul |

RF GNSS pad (Pin9) – GNSS RX path

3. 9.1 Bandwidth Support

| Band | Bandwidth | | | | | | |
|-------------|-----------|-------|-------|--------|--------|--------|--|
| Danu | 1.4 MHz | 3 MHz | 5 MHz | 10 MHz | 15 MHz | 20 MHz | |
| LTE Band 2 | ✓ | ✓ | ~ | ~ | ~ | ✓ | |
| LTE Band 4 | ~ | ✓ | ~ | ~ | ~ | ✓ | |
| LTE Band 12 | ~ | ✓ | ~ | ~ | - | - | |

Table 3-5. Bandwidth support

3. 9.2 RF Transmission Specifications

| Band | Item | Parameter | Unit | Min. | Тур. | Max. |
|-------------|---------------|-------------------|------|------|------|------|
| LTE Band 2 | Max. TX Power | 20 MHz 1 RBs/QPSK | dBm | 20.3 | 23 | 25.7 |
| LTE Band 4 | Max. TX Power | 20 MHz 1 RBs/QPSK | dBm | 20.3 | 23 | 25.7 |
| LTE Band 12 | Max. TX Power | 10 MHz 1 RBs/QPSK | dBm | 20.3 | 23 | 25.7 |

Table 3-6. Conductive Tx output power

Notes: 1. The RF transmission specification is defined at the LGA pad.

2. Complies with 3GPP test standards.

3. 9.3 RF Receiver Specifications

| Band | Item | Parameter | Unit | Min. | Тур. | Max. |
|-------------|----------------|------------------|------|------|------|--------|
| LTE Band 2 | RX Sensitivity | 5 MHz with 4 RBs | dBm | | | -100.3 |
| LTE Band 4 | RX Sensitivity | 5 MHz with 4 RBs | dBm | | | -102.3 |
| LTE Band 12 | RX Sensitivity | 5 MHz with 4 RBs | dBm | | | -99.3 |

Table 3-7. Conductive Rx sensitivity—3GPP

Notes: 1. The RF receiver specification is defined at the LGA pad.

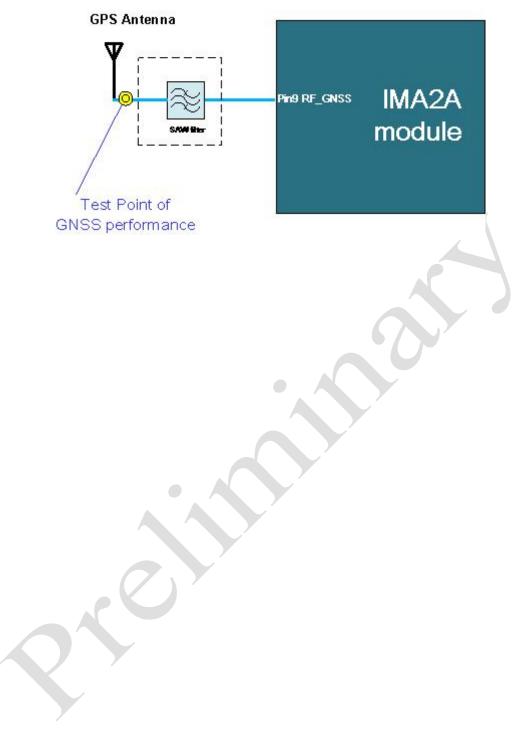
2. Compliant with 3GPP test standards

3.9.4 RF GNSS Receiver Specifications

| Test Items | Parameter | Min. | Тур. | Max. | |
|----------------------------------------|------------------------------------|------|------|------|--|
| Cold start TTFF | At –130 dBm | - | TBD | - | |
| Hot start TTFF | At –130 dBm | - | TBD | - | |
| CEP-50 accuracy | Open sky with –130 dBm input | - | TBD | - | |
| Cold start sensitivity | Acquire first with signal level | - | TBD | - | |
| Tracking sensitivity (GPS) | Detecting an in-view satellite 50% | - | TBD | - | |
| | of the time | | | | |
| Tracking sensitivity | Detecting an in-view satellite 50% | - | TBD | - | |
| (GLONASS) | of the time | | | | |
| Table 3-8. Conductive GNSS performance | | | | | |

Note 1: Test points are displayed below.



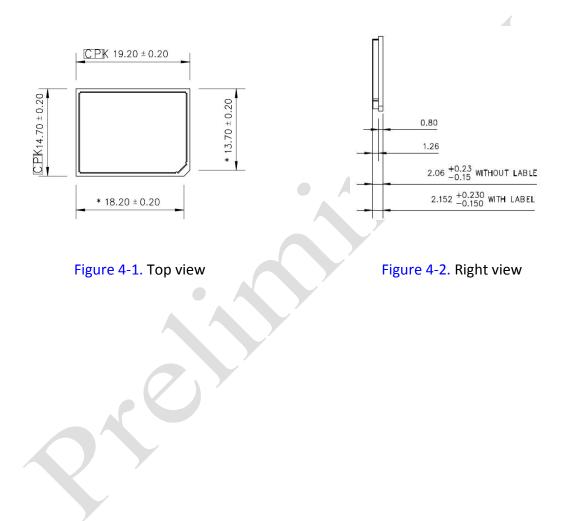




4. Mechanical Information

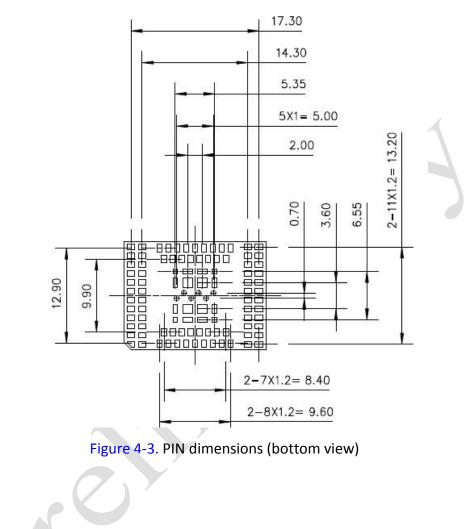
4.1 Physical Dimensions

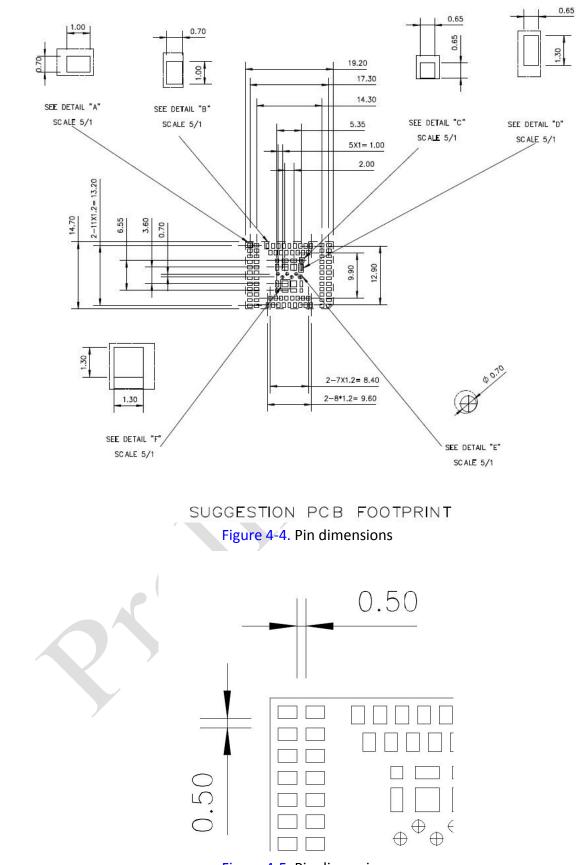
Physical dimensions are illustrated in Figure 4-1 and Figure 4-2 below.



4.2 Pin Dimensions

Pin dimensions are illustrated in Figure 4-3, Figure 4-4, and Figure 4-5 below.





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Figure 4-5. Pin dimensions

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4.3 Marking Information

The IMA2A series module label is illustrated below.



- P/N: Variable; for the specific customer
- S/N: Variable; unique for each module
- IMEI: Variable; unique for each module
- FCC: TBD
- IC: TBD

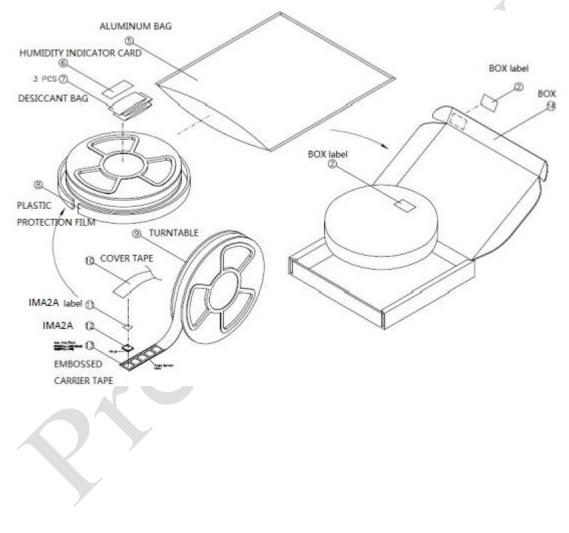
If customers request their own S/Ns and IMEIs, they should inform WNC before production. The S/N and IMEI only can be written once onto each unit.



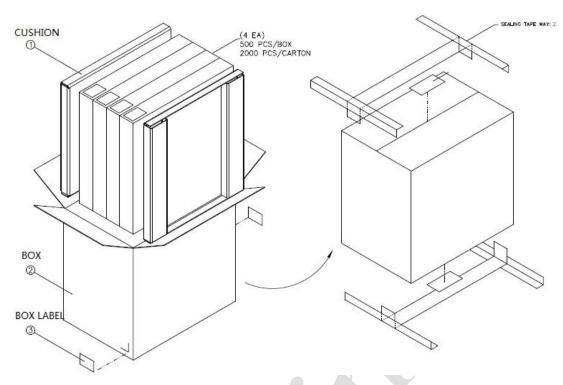
5. Packing Information

5.1 Tape-and-Reel Package

The module is delivered in tape-and-reel packaging based on MPQ (500 pcs./reel; 4 reels/carton).

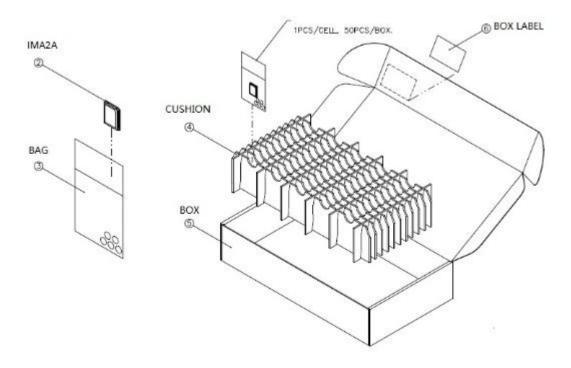






5.2 Single Packaging for Samples

Samples are packaged at 50 pcs./box. There is no vacuum packaging. Samples must be baked for 8 hours at 85 °C before SMT.





6. Design Guide

6.1 Power Trace Design

Power trace layout suggestion: At least 22 μ F, 0.1 μ F, and 100 pF capacitors are required; place the capacitors as close to the power pins as possible. Power trace should possess sufficient line width to withstand its respective current listed in the table below.

| Net Name | Peak Current Value for PCB Power Trace Design | | | |
|---------------------|-----------------------------------------------|--|--|--|
| Power (37–42) total | 1 A | | | |
| VREF | 50 mA | | | |
| UIM_VCC | 30 mA | | | |

Table 6-1. Reference current for power trace

Please select the DCDC that can satisfy the output (1 A) as the power supply of the module.

6.2 RF Layout guidance

We recommend that a ground not be present under the surface of the RF pads in the layout. Details are included below. Layer 2 has the same exclusion area as Layer 1.

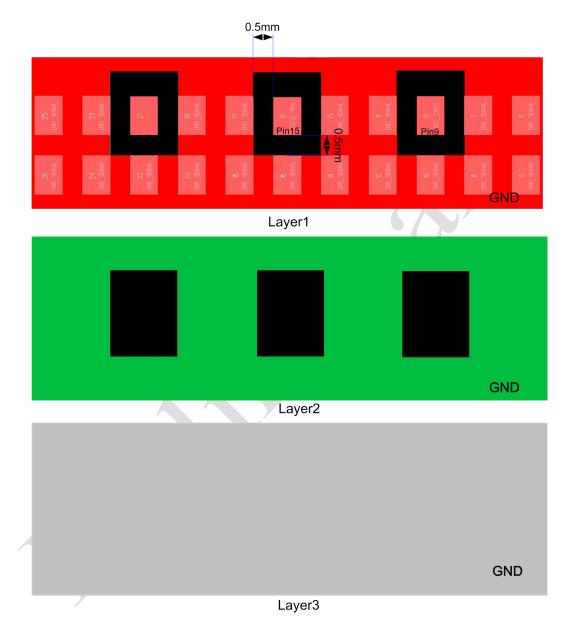


Figure 6-1. Sample RF pad layout

The RF trace between RF pads and antenna should as shorter as possible with 500hm characteristic impedance.

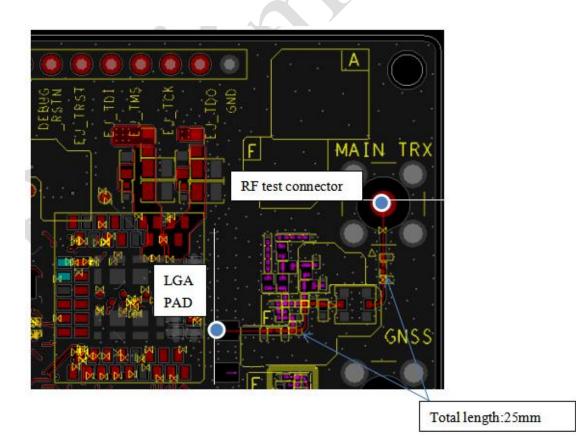
The characteristic impedance depends on the dielectric of PCB, the track width and the

ground plane spacing. Coplanar Waveguide type is required. The detail simulation as below.

| L = 0.588 fraction of c $R = 4.6 frequency: 1 GHz$ $L = 0.144 frequency: 1 GHz$ | Coplanar Waveguide | Airoundplane O No Groundplane |
|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------|
| $\begin{array}{c} \uparrow \\ H \\ \rightarrow \\ \leftarrow \\ G \\ \end{array}$ $\begin{array}{c} 1.5 \\ FR-4 \\ \hline \\ Frequency: \end{array}$ $\begin{array}{c} 1.5 \\ 1.5 \\ \hline \\ B \\ \hline \\ C \\ C \\ FR-4 \\ \hline \\ FR-4 \\ \hline \\ Frequency: \end{array}$ $\begin{array}{c} 1.5 \\ B \\ C \\ B \\ \hline \\ C \\ FR-4 \\ \hline \\ FR-4 \\ \hline \\ Frequency: \end{array}$ $\begin{array}{c} 1.5 \\ C \\ B \\ C \\ C \\ FR-4 \\ \hline \\ FR-4 \\ \hline \\ Frequency: \end{array}$ $\begin{array}{c} 1.5 \\ C \\ B \\ C \\ C \\ C \\ FR-4 \\ \hline \\ FR-4 \\ \hline \\ Frequency: \end{array}$ $\begin{array}{c} 1.5 \\ C \\ B \\ C \\ C$ | | |
| Dielectric: $\varepsilon_r = 4.6$ 1.0 Wavelength = 6944.029 mil Vp = 0.588 fraction of c FR-4 \checkmark $\varepsilon_{eff} = 2.89$ Frequency: 1 GHz | $\begin{array}{c} \uparrow \\ H \end{array} \rightarrow \begin{array}{c} \downarrow \\ \downarrow \\ W \end{array} \begin{array}{c} 1.5 \\ 1.5 \end{array}$ | Elect Length = 0.144 λ |
| Frequency: 1 GHz Shape factor = 0.347 | Dielectric: ɛr= 4.6 | 1.0 Wavelength = 6944.029 mil Vp = 0.588 fraction of c |
| | | |

The RF trace of the test board which was used in the FCC test is defined as below.

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6.3 RF Matching Guide

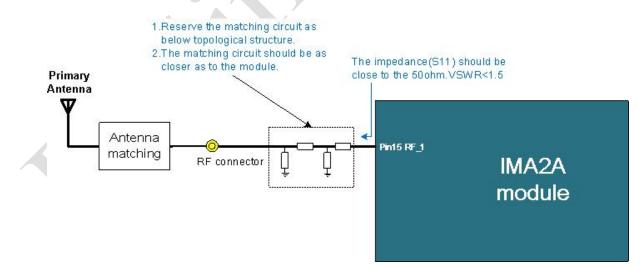


Figure 6-2. RF matching guide

6.4 GNSS External Circuit Design

To be updated in the future.

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6.5 Interference and Sensitivity

This section includes tips to help developers identify interferences that may affect the IMA2A module when used in systems.

- Interference from other wireless devices
 - We highly recommend checking the RX performance of entire systems within the shielding environment.
 - Good isolation (ex.: Wi-Fi antenna, GPS antenna) is required between the other wireless system antenna and the IMA2A module LTE antenna.

■ Interference from the host interface

 High-speed signal-switching elements in systems can easily couple noise into the module (ex.: DDR memory, LCD modules, DC-to-DC converters, PCM signals). Methods to avoid sources of interference

- Antenna location is important; we recommend directing the

antenna away from high-speed switching signals. Furthermore, the trace from the module to the antenna should be as short as possible and must be shielded by complete grounding.

- The IMA2A module is well shielded; high-speed elements (Ex.: DDR

memory, LCD modules, DC-to-DC converters, PCM signals) on a system should have shielding reserved during the early stages of development.

6.6 Antenna design requirement

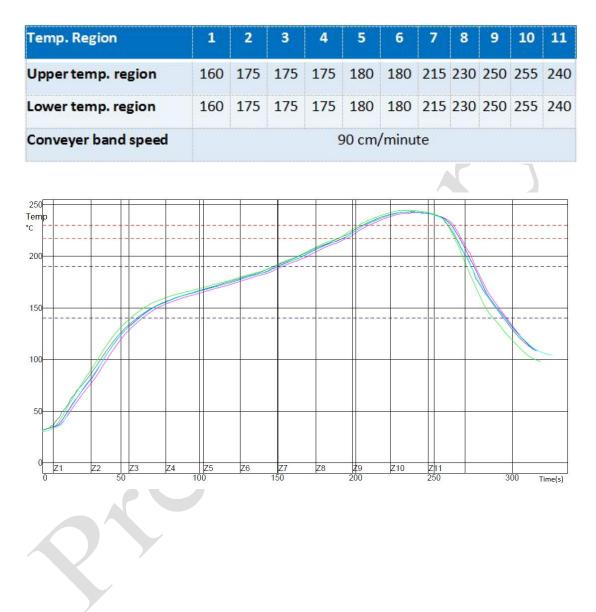
| ANTENNA REQUIREMENTS for IMA2A | | | |
|-----------------------------------------------------------------------|---------------------------------------------------------|--|--|
| Frequency range | LTE band II(1900) : 1850MHz-1910MHz, 1930MHz-1990MHz | | |
| | LTE Band IV(1700) : 1710MHz-1755MHz, 1710MHz-1755MHz | | |
| | LTE Band XII(700) : 699MHz-716 MHz, 729 MHz-746 MHz | | |
| Bandwidth | LTE band II(1900) : 60 MHz | | |
| | LTE Band IV(1700) : 45 MHz | | |
| | LTE Band XII(700) : 17 MHz | | |
| Polarization | Linear | | |
| Radiation pattern | Omni-directional | | |
| Impedance | 50 ohm | | |
| Input power | > 24dBm Average power in LTE | | |
| Efficiency recommended | >40% (below 960MHz) | | |
| | >50% (over 1710MHz) | | |
| VSWR absolute max | ≤ 3:1 | | |
| VSWR absolute recommended | ≤ 2:1 | | |
| Antenna ruggedness(Output RF load mismatch ruggedness at ANT pins) | 10:1 (max) VSWR | | |

The antennas shall must meet below specification:



6.7 Mounting Considerations

This section details the recommended reflow profile when the module is mounted onto other boards.



| WNC_ |
|------|
|------|

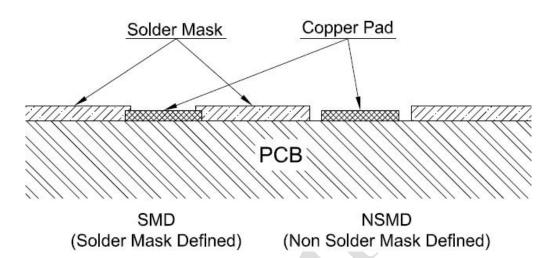
| PWI = 91% | U13-1 | U13-4 | J45-2 | U29-2 | J44-3 | Temp. Difference |
|--------------------|--------|--------|--------|--------|--------------------|------------------|
| FWI- 31/0 | | | | | | remp. Difference |
| Preheat from 140-1 | L90°C | | | | | |
| | 89.22 | 88.45 | 87.27 | 89.00 | 90.95 | 3.68 |
| | 10% | 5% | -1% | 9% | 20% | |
| Melt-out Time/230 | °C | | | | | |
| | 54.12 | 55.80 | 54.72 | 55.01 | 56.98 | 2.86 |
| | 41% | 58% | 47% | 50% | 70% | |
| Max Temp | | | | | | |
| | 242.12 | 242.73 | 243.00 | 242.88 | 244.45 | 2.33 |
| | 21% | 27% | 30% | 29% | 45% | |
| Total Time/217°C | | | | | | |
| | 73.89 | 75.48 | 75.89 | 72.9 | 75.31 | 2.99 |
| | -44% | -38% | -36% | -48% | - <mark>39%</mark> | |
| Gradient1 (100–150 | о°с) | | | | | |
| | 1.85 | 1.88 | 1.84 | 1.9 | 1.93 | 0.09 |
| | 23% | 25% | 23% | 27% | 29% | |

Process limit:

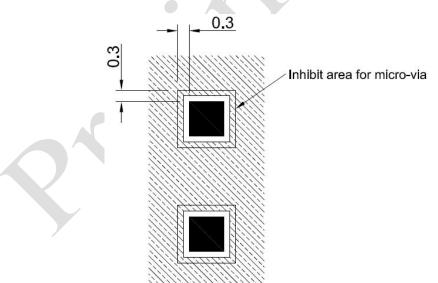
| Solder Paste | | Lead-free | |
|------------------------------------------------------------------|------|------------|------|
| Profile feature | Min. | Max. | Unit |
| Gradient1 (Target = 1.5) (100 °C–150 °C) (Time period = 20 s) | 0 | 3 | °C/S |
| Preheat time from 140 °C to 190 °C | 70 | 105 | S |
| Time maintained above 230 °C | 40 | 60 | S |
| Peak package body temperature | 230 | 250 | °C |
| Time maintained above 217 °C | 60 | 110 | S |

6.8 PCB Pad Design

We recommend a non-solder mask with defined (NSMD) type for the solder pads of the PCB on which IMA2A modules will be mounted. This type of design enables high soldering reliability during the SMT process.



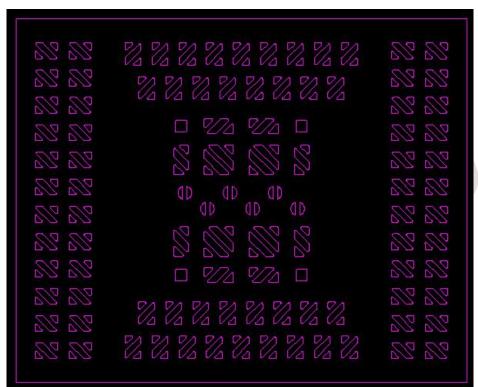
We recommend not placing via or micro-via that is not covered by solder resistance within 0.3 mm around the pads unless it carries the same signal of the pad itself. Refer to the following figure.



Only blind holes are allowed in the pad. Through holes are not allowed.

6.9 Stencils

WNC suggests using a stencil-foil with thickness of more than (or equaling to) 0.12 mm for module SMTs and a diagonal pattern to prevent voids during reflow.



Stencil-foil drawing

6.10 LTE Power Saving Mode

Note: Details will be provided in a future revision of this document.



7. Safety Recommendations

Be sure use of this product is allowed in the country and in the environment required. Use of this product may be dangerous and must be avoided in the following areas:

- Where it may interfere with other electronic devices in environments such as hospitals, airports, and aircraft
- Where there is a risk of explosion such as gasoline stations and oil refineries

The user is responsible for compliance with the legal and environmental regulations of their location of use.

Do not disassemble the product; any evidence of tampering will compromise the warranty's validity.

We recommend following the instructions of the hardware user guides for a correct wiring of the product. The product must be supplied with a stabilized voltage source, and the wiring must conform to relevant security and fire-prevention regulations.

This product must be handled with care; avoid any contact with the pins because electrostatic discharge may damage the product. Exercise the same level of caution regarding the UIM card; carefully check the instructions for its use. Do not insert or remove the UIM when the product is in power-saving mode.

The system integrator is responsible for the functioning of the final product; therefore, care must be taken for the external components of the module as well as for project or installation issues—there may be a risk of disturbing the GSM network or external devices or of impacting device security. If you have any questions, refer to the technical documentation and the relevant regulations in force.

Every module must be equipped with a proper antenna with specific characteristics. The antenna must be installed with care in order to avoid any interference with other electronic devices.



8. Initialisms

Initialisms and Definitions

| Initialism | Definition |
|------------|-------------------------------------------------|
| AC | Alternating current |
| DC | Direct current |
| ETSI | European Telecommunications Standards Institute |
| GND | Ground |
| GPIO | General purpose input output |
| I/O | Input/output |
| IoT | Internet of Things |
| 12C | Inter-integrated circuit |
| LGA | Land grid array |
| LTE | Long Term Evolution |
| N/A | Not/applicable |
| OS | Operating system |
| PIN | Personal identification number |
| SIM | Subscriber identity module |
| SPI | Serial peripheral interface |
| UART | Universal asynchronous receiver-transmitter |
| UIM | User identity module |
| USB | Universal serial bus |
| Vref | Voltage reference |
| RFU | Reserved for future use |
| WNC | Wistron NeWeb Corporation |